

High Power Lamp

EHP-5393/SUR01-P01

Features

- Popular 10 mm package.
- View angle:25°.
- High light flux output
- Soldering methods: Dip soldering.
- Optical efficiency: 42 lm/W
- Thermal resistance (junction to leadframe): 13K/W
- The product itself will remain within RoHS compliant version.
- ESD-withstand voltage: up to 4KV



- The series is specially designed for applications requiring higher brightness.
- The LED lamps are available with different colors, intensities, epoxy colors, etc.

Applications

- Flashlight
- Sunshine light.
- Advertising Signs.
- Back lighting.



Device Selection Guide

LEDD AN	Cl	I Cal		
LED Part No.	Material	Emitted Color	Lens Color	
EHP-5393/SUR01-P01	AlGaInP	Brilliant Red	Water Clear	

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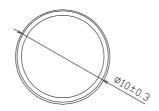
Device Number: DLE-539-002 Prepared date:12-25-2007 Prepared by: Dantechen

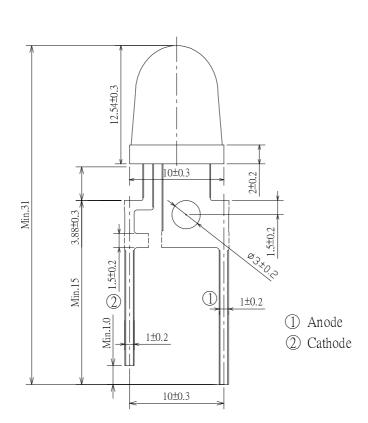


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Package Dimensions







Notes:

- Other dimensions are in millimeters, tolerance is 0.25mm except being specified.
- Protruded resin under flange is 1.5mm Max LED.
- Bare copper alloy is exposed at tie-bar portion after cutting.

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Absolute Maximum Rating ($T_a=25^{\circ}C$)

Parameter	Symbol	Absolute Maximum Rating	Unit
Forward Current	I_{F}	385	mA
Thermal resistance (junction to leadframe)	$R_{ ext{th(j-l)}}$	13	K/W
Operating Temperature	T_{opr}	-40 ~ +85	$^{\circ}\! \mathbb{C}$
Storage Temperature	T_{stg}	-40 ~ +100	$^{\circ}\! C$
Electrostatic Discharge	ESD	4K	V
Soldering Temperature	T_{sol}	260	$^{\circ}\! { m C}$
Power Dissipation	P_d	1.3	W
Reverse Voltage	V_R	5	V
Zener Reverse Current	Iz	100	mA

Notes: Soldering time ≤ 5 seconds.

Electro-Optical Characteristics (T_a=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Total Flux	Flux	27	35	45	lm	
Peak Wavelength	λp		632		nm	
Dominant Wavelength	λd	620	624	628	nm	I _F =350mA
Viewing Angle	2 0 1/2		25		deg	
Forward Voltage	V_{F}	2.0	2.4	3.0	V	
Reverse Current	I_R			10	μΑ	V _R =5V
Zener Reverse Voltage	Vz	5.2			V	Iz=5mA

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Rank Combination (I_F=350mA)

Rank	R1	R2	R3
Total Flux	27~33	33~39	39~45

^{*}Measurement Uncertainty of Total Flux: ±15% Unit:lm

Forward Voltage Combination (V at 350mA)

Rank	2	3	4	5	6
Forward Voltage	2.0~2.2	2.2~2.4	2.4~2.6	2.6~2.8	2.8~3.0

^{*}Measurement Uncertainty of Forward Voltage: ±0.1V Unit:V

Color Combination (at 350mA)

Rank	1	2	
Dominant Wavelength	620~624	624~628	

^{*}Measurement Uncertainty of Dominant Wavelength ±1.0nm

Unit:nm

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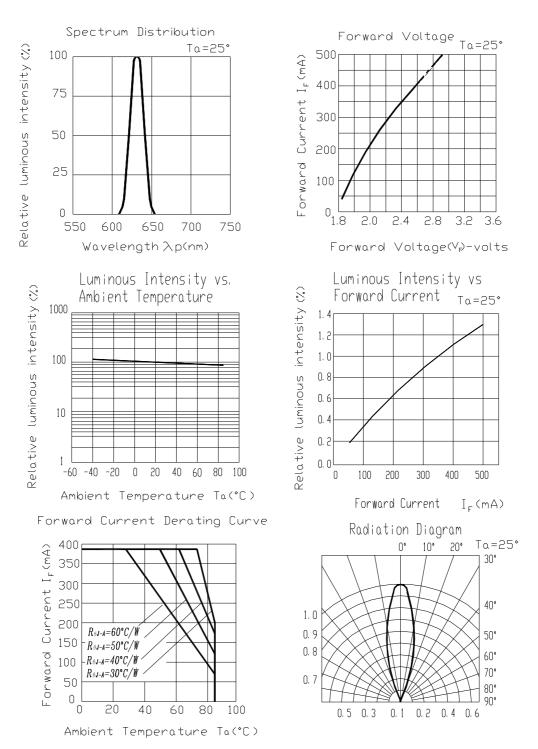
^{*}The quantity ratio of the ranks is decided by EVERLIGHT.



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Typical Electro-Optical Characteristics Curves



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Packing Quantity Specification

1.100PCS/1Bag, 5Bags/1Box

2.10Boxes/1Carton

Label Form Specification

EVERLIGHT

CPN:

P/N:

RoHS

EHP-5393/SUR01-P01

QTY:

CAT:

HUE:

LOT NO:

REF:

MADE IN TAIWAN

CPN: Customer's Production Number

P/N: Production Number QTY: Packing Quantity

CAT: Ranks of Total Flux and Forward Voltage

HUE: Ranks of Dominant Wavelength

REF: Reference

LOT No: Lot Number

MADE IN TAIWAN: Production Place

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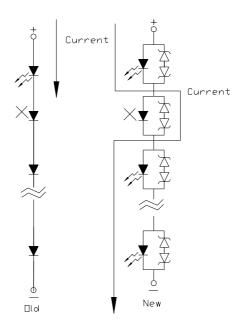


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Notes

- 1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
- These specification sheets include materials protected under copyright of EVERLIGHT corporation. Please don't reproduce or cause anyone to reproduce them without EVERLIGHT's consent.
- 4. Below the zener reference voltage Vz, all the current flows through LED and as the voltage rises to Vz, the zener diode "breakdown." If the voltage tries to rise above Vz current flows through the zener branch to keep the voltage at exactly Vz.
- 5. When the LED is connected using serial circuit, if either piece of LED is no light up but current can't flow through causing others to light down. In new design, the LED is parallel with zener diode. if either piece of LED is no light up but current can flow through causing others to light up.



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6. If the emitter is operated, consider using metal heat sink with the lowest possible thermal resistance. We do not recommend lighting the emitter for more than a few seconds without an additional heat sink. For the thermal performance using a flat heat sink, allow an exposed surface area of about 25mm² at least.

7. Soldering Condition

Careful attention should be paid during soldering. When soldering, leave more then 3mm from solder joint to case, and soldering beyond the base of the tie bar is recommended.

Avoiding applying any stress to the lead frame while the LEDs are at high temperature particularly when soldering.

Recommended soldering conditions:

Hand Soldering		DIP Soldering		
Temp. at tip of iron	350°C Max. (30W	Preheat temp.	100°C Max. (60 sec Max.)	
Temp. at up of from	Max.)	Treneut temp.		
Soldering time	3 sec Max.	Bath temp.	260 Max.	
Distance	3mm Min.(From solder	Bath time.	5 sec Max.	
	joint to case)			
		Distance	3mm Min.	

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